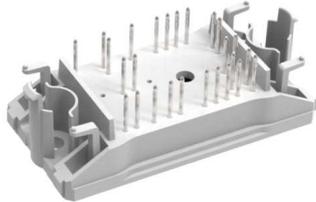
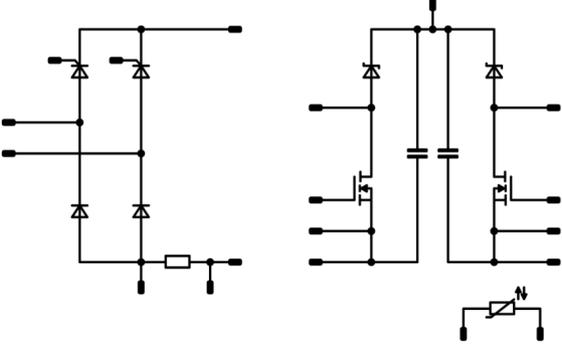




Vincotech

<i>flow</i> PFC 0	600 V / 99 mΩ
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Features</div> <ul style="list-style-type: none"> Vincotech clip-in housing Compact and low inductance design Suitable for Interleaved topology Suitable for current sensing in source C6 series CoolMos™ and SiC boost diode 	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">flow0 17mm housing</div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Target applications</div> <ul style="list-style-type: none"> Welding SMPS Motor Drives UPS Battery Charger 	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Schematic</div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Types</div> <ul style="list-style-type: none"> 10-F0062TA099FS-P980D59 	

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Rectifier Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	51	A
Surge (non-repetitive) forward current	I_{FSM}	50 Hz Single Half Sine Wave $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	280	A
Surge current capability	I^2t		390	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	68	W
Maximum Junction Temperature	T_{jmax}		150	°C



Vincotech

Parameter	Symbol	Condition	Value	Unit
Rectifier Thyristor				
Repetitive peak reverse voltage	V_{RRM}		1200	V
Forward average current	I_{FAV}	sine, $d = 0,5$ $T_j = T_{jmax}$	$T_s = 80\text{ °C}$ 48	A
Surge forward current	I_{FSM}	$t_p = 10\text{ ms}$	$T_j = 25\text{ °C}$ 250	A
I^2t value	I^2t		310	A ² s
Power dissipation	P_{tot}	$T_j = T_{jmax}$	$T_s = 80\text{ °C}$ 71	W
Maximum Junction Temperature	T_{jmax}		150	°C

PFC Switch

Drain-source voltage	V_{DSS}		600	V
Drain current	I_D	$T_j = T_{jmax}$	$T_s = 80\text{ °C}$ 18	A
Peak drain current	I_{DM}	t_p limited by T_{jmax}	112	A
Avalanche energy, single pulse	E_{AS}	$I_D = 6,6\text{ A}$ $V_{DD} = 50\text{ V}$	796	mJ
Avalanche energy, repetitive	E_{AR}	$I_D = 6,6\text{ A}$ $V_{DD} = 50\text{ V}$	1,20	mJ
Avalanche current, repetitive	I_{AR}	t_p limited by T_{jmax} $PAV = E_{AR} * f$	6,6	A
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} = 480\text{ V}$	50	V/ns
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	$T_s = 80\text{ °C}$ 88	W
Gate-source voltage	V_{GSS}		±20	V
Reverse diode dv/dt	dv/dt		15	V/ns
Maximum Junction Temperature	T_{jmax}		150	°C

PFC Diode

Peak Repetitive Reverse Voltage	V_{RRM}		600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$	$T_s = 80\text{ °C}$ 15	A
Repetitive peak forward current	I_{FRM}		67	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	$T_s = 80\text{ °C}$ 35	W
Maximum Junction Temperature	T_{jmax}		175	°C



Vincotech

Parameter	Symbol	Condition	Value	Unit
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PFC Shunt

DC forward current	I_F	$T_c = 105\text{ °C}$	35	A
Power dissipation	P_{tot}	$T_c = 105\text{ °C}$	5	W

PFC Capacitance

Maximum DC voltage	V_{MAX}		500	V
Operation Temperature	T_{op}		-55...+125	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		$-40...+(T_{jmax} - 25)$	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Voltage	$t_p = 2s$	4000	V
Creepage distance				min. 12,7	mm
Clearance				min. 12,7	mm
Comparative Tracking Index	CTI			> 200	



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit	
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{GS} [V]	V_r [V]	I_C [A]	I_D [A]	I_F [A]		T_j [°C]

Rectifier Diode

Static

Forward voltage	V_F				50	25 125		1,31 1,33	1,4	V
Reverse leakage current	I_r			1600		25 150			20 1500	μ A

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						1,03		K/W
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Rectifier Thyristor

Static

Forward voltage	V_T				30	25 125		1,26 1,22	1,33 1,32	V
Threshold voltage (for power loss calc. only)	V_{th}				30	25 125			0,9	V
Slope resistance (for power loss calc. only)	r_t				30	25 125			9	m Ω
Reverse current	I_r			1200		25 125			0,01 2	mA
Gate controlled delay time	t_{GD}	$T_{vj} = 25$ °C $I_G = 0,5$ A $di/dt = 0,5$ A/ μ s				25 125		2		μ s
Gate controlled rise time	t_{GR}	$V_0 = 2/3 V_{DRM}$		1072		25 125		2		μ s
Critical rate of rise of off-state voltage	$(dv/dt)_{cr}$					25 125			500	V/ μ s
Critical rate of rise of on-state current	$(di/dt)_{cr}$	$I_G = 0,2$ A $t_p = 200$ μ s $di_G/dt = 0,2$ A/ μ s $f = 50$ Hz		$2/3 V_{DRM}$		25 125			150	A/ μ s
Circuit commutated turn-off time	t_q	$dv/dt = 20$ V/ μ s $-di/dt = 10$ μ s $I_T = 2,6$ A $t_p = 200$ μ s		100		25 125		150		μ s
Holding current	I_H			6		25 125			220	mA
Latching current	I_L	$t_p = 10$ μ s $I_G = 0,2$ A $di_G/dt = 0,2$ A/ μ s				25 125			90	mA
Gate trigger voltage	V_{GT}					25 -40			1,3 1,6	V
Gate trigger current	I_{GT}			6		25 -40	11		28 50	mA
Gate non-trigger voltage	V_{GD}			$2/3 V_{DRM}$		25 125			0,2	V
Gate non-trigger current	I_{GD}					25 125			1	mA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						1		K/W
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Vincotech

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{GS} [V] V_r [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

PFC Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		10		18,1	25 125 150		100 209		mΩ
Gate-source threshold voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}$			0,00121	25 125	2,5	3	3,5	V
Gate to Source Leakage Current	I_{GSS}		20	0		25 125			100	nA
Zero Gate Voltage Drain Current	I_{DSS}		0	600		25 125			5	μA
Internal gate resistance	r_g							1,6		Ω
Gate charge	Q_G							119		nC
Gate to source charge	Q_{GS}		0/10	480	18,1	25		14		
Gate to drain charge	Q_{GD}							61		
Short-circuit input capacitance	C_{iss}							2660		pF
Short-circuit output capacitance	C_{oss}	$f = 1\text{MHz}$	0	100		25		154		
Reverse transfer capacitance	C_{rss}							7		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda=3,4 \text{ W/mK}$						0,8		K/W
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MOSFET Switching

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 2 \Omega$ $R_{gon} = 2 \Omega$	10	400	18	25		20		ns
Rise time	t_r					125		19		
Turn-off delay time	$t_{d(off)}$					25		4		
Fall time	t_f					125		4		
Turn-on energy (per pulse)	E_{on}					25		90		
Turn-off energy (per pulse)	E_{off}	125		92						
		25		3		0,053				mWs
		125		4		0,063				
		25				0,015				
		125				0,024				



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Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{GS} [V] V_r [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

PFC Diode

Static

Forward voltage	V_F				10	25 125 150		1,49 1,69 1,78	2,4	V
Reverse leakage current	I_r			600		25 150			50 200	μ A

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						2,75		K/W
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FWD Switching

Peak recovery current	I_{RRM}	$di/dt = 5949$ A/ μ s $di/dt = 4798$ A/ μ s	10	400	18	25 125		18 16		A
Reverse recovery time	t_{rr}					25 125		7 7		ns
Recovered charge	Q_r					25 125		0,060 0,051		μ C
Reverse recovered energy	E_{rec}					25 125		0,003 0,002		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125		8682 5922		A/ μ s

PFC Shunt

R1 value	R						4		2000	m Ω
Temperature coefficient	t_c					20 - 60			50	ppm/K
Internal heat resistance	R_{thi}								13	K/W
Inductance	L								3	nH

PFC Capacitance

Capacitance	C							270		nF
Tolerance								-20	+20	%



Vincotech

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{GS} [V] V_r [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

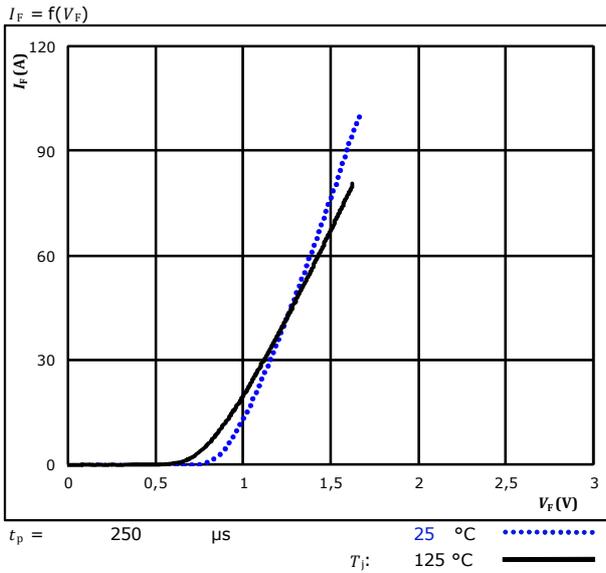
Thermistor

Rated resistance	R				25		22		$k\Omega$
Deviation of R100	$\Delta_{R/R}$	R100=1484 Ω			100	-5		5	%
Power dissipation	P				25		5		mW
Power dissipation constant					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1\%$			25		3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1\%$			25		4000		K
Vincotech NTC Reference								I	

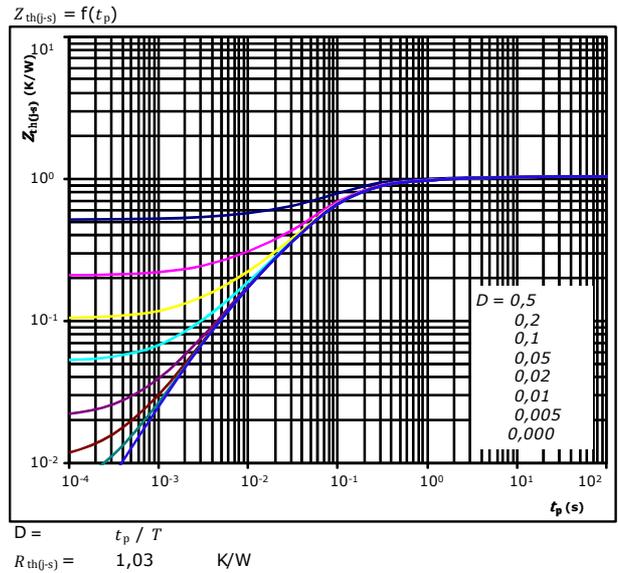


Rectifier Diode Characteristics

Typical forward characteristics Diode



Transient thermal impedance as a function of pulse width Diode



Diode thermal model values

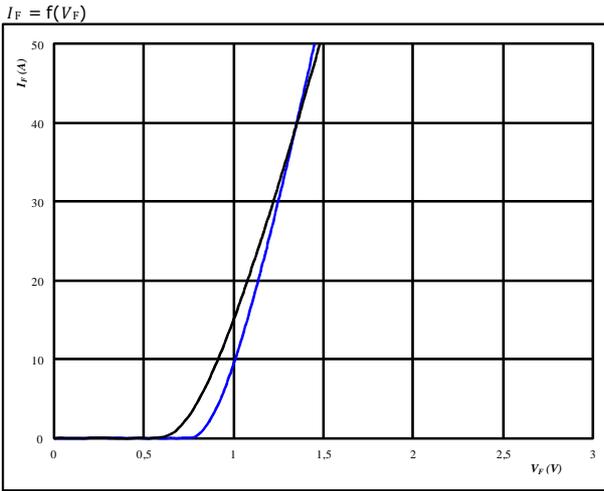
R (K/W)	τ (s)
4,2180E-02	6,7950E+00
1,3600E-01	6,2940E-01
6,3390E-01	9,0540E-02
1,4600E-01	3,1010E-02
6,3770E-02	4,7560E-03
1,2000E-02	1,5250E-02



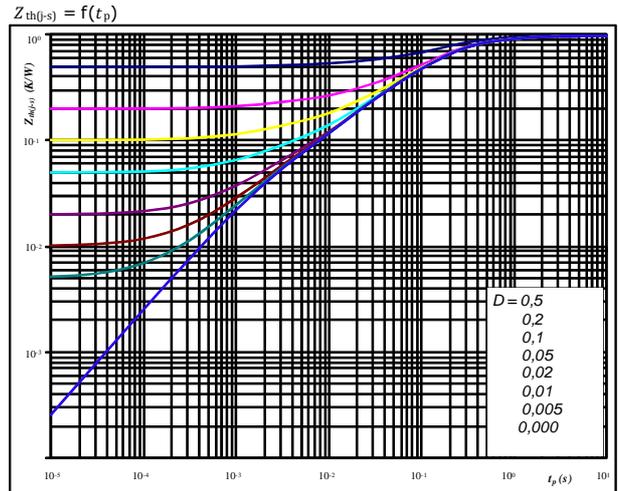
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Rectifier Thyristor Characteristics

Typical forward characteristics Thyristor



Transient thermal impedance as a function of pulse width Thyristor

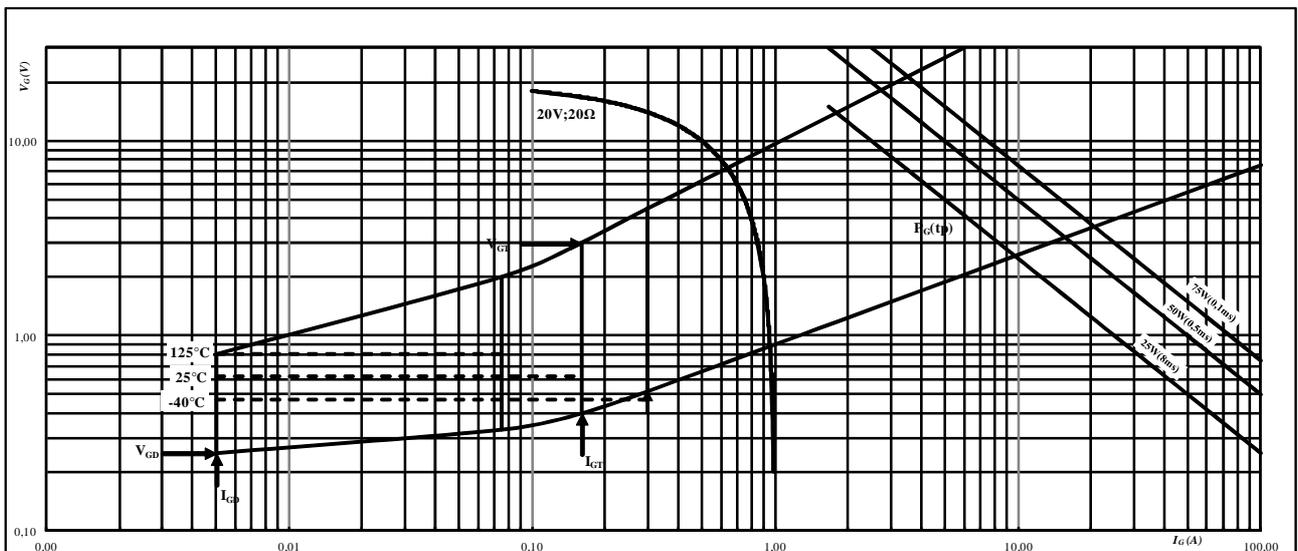


$D = \frac{t_p}{T}$
 $R_{th(j-s)} = 1 \text{ K/W}$

FWD thermal model values

R (K/W)	τ (s)
2,07E-02	2,12E+01
1,60E-01	9,80E-01
6,58E-01	1,61E-01
1,28E-01	2,45E-02
3,31E-02	2,04E-03

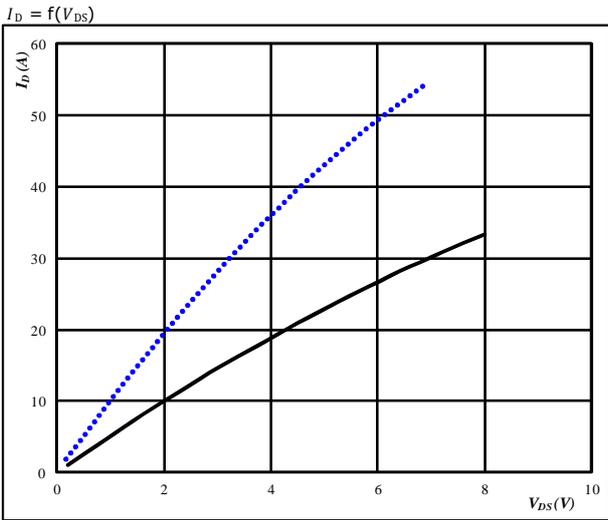
Gate trigger characteristics Thyristor





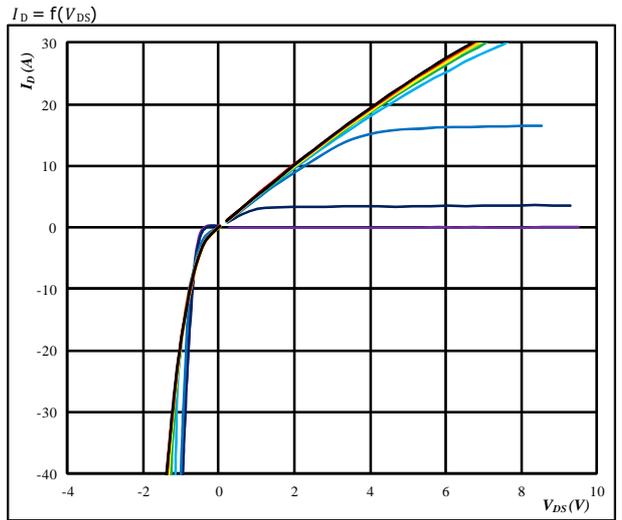
PFC Switch Characteristics

Typical output characteristics MOSFET



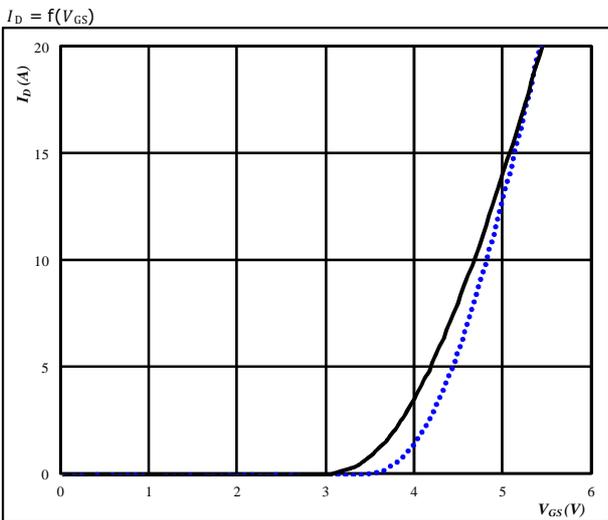
$t_p = 250 \mu s$
 $V_{GS} = 10 V$
 $T_j: 25 \text{ } ^\circ C$ (dotted blue line)
 $T_j: 125 \text{ } ^\circ C$ (solid black line)

Typical output characteristics MOSFET



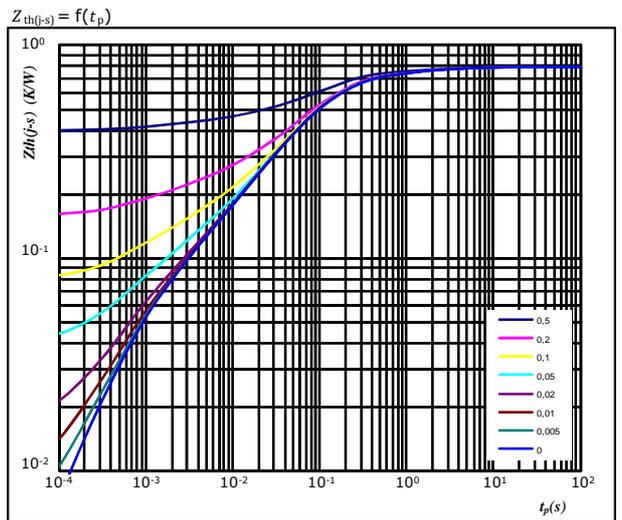
$t_p = 250 \mu s$
 $T_j = 125 \text{ } ^\circ C$
 V_{GS} from 3 V to 13 V in steps of 1 V

Typical transfer characteristics MOSFET



$t_p = 100 \mu s$
 $V_{DS} = 10 V$
 $T_j: 25 \text{ } ^\circ C$ (dotted blue line)
 $T_j: 125 \text{ } ^\circ C$ (solid black line)

Transient thermal impedance as a function of pulse width MOSFET



$D = t_p / T$
 $R_{th(j-s)} = 0,8 \text{ K/W}$

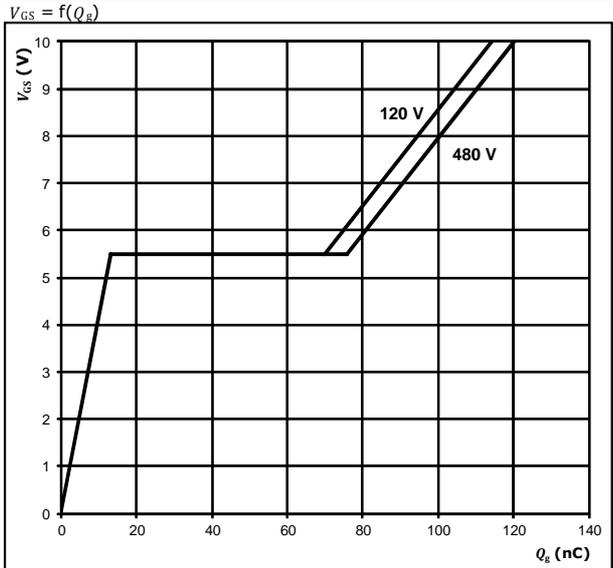
R (K/W)	τ (s)
6,19E-02	2,26E+00
1,10E-01	4,08E-01
4,12E-01	9,23E-02
1,04E-01	2,31E-02
5,73E-02	5,67E-03
4,98E-02	8,49E-04



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PFC Switch Characteristics

Gate voltage vs Gate charge MOSFET

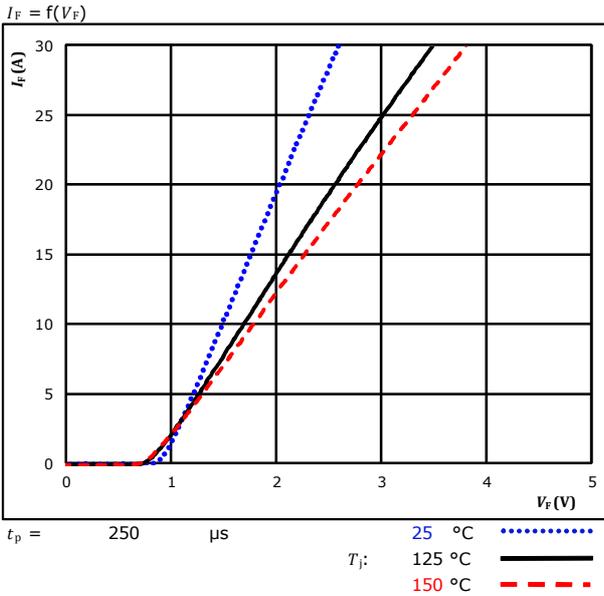


At
 $I_D = 18$ A

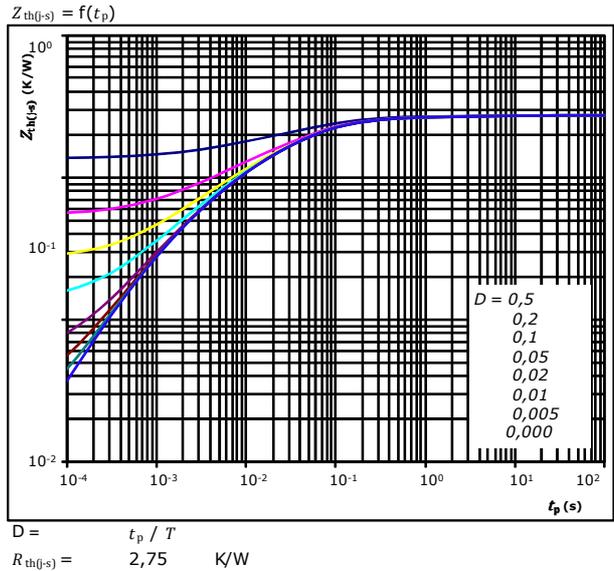


PFC Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD

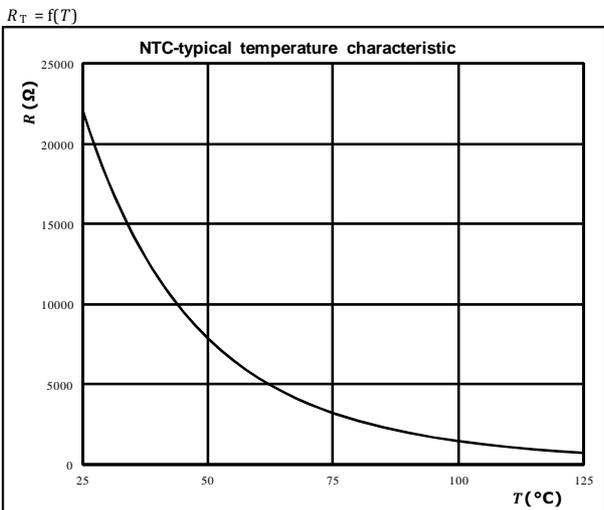


FWD thermal model values

R (K/W)	τ (s)
7,6230E-02	7,9980E+00
2,3080E-01	4,5940E-01
1,1880E+00	6,1570E-02
6,9160E-01	1,3630E-02
4,4070E-01	3,2880E-03
1,1880E-01	6,6820E-04

Thermistor

Thermistor typical temperature characteristic
Typical NTC characteristic as a function of temperature

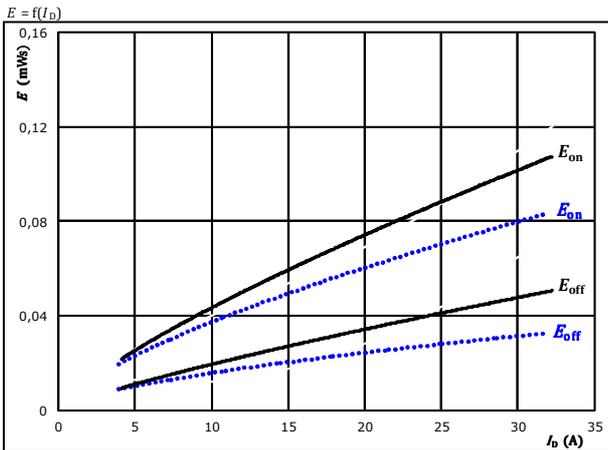




PFC Switching Characteristics

figure 1. MOSFET

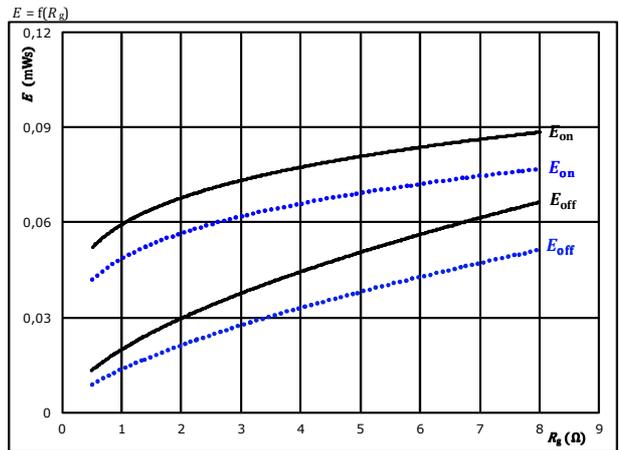
Typical switching energy losses as a function of drain current



With an inductive load at
 $V_{DS} = 400$ V
 $V_{GS} = 10$ V
 $R_{g\text{on}} = 2$ Ω
 $R_{g\text{off}} = 2$ Ω
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)

figure 2. MOSFET

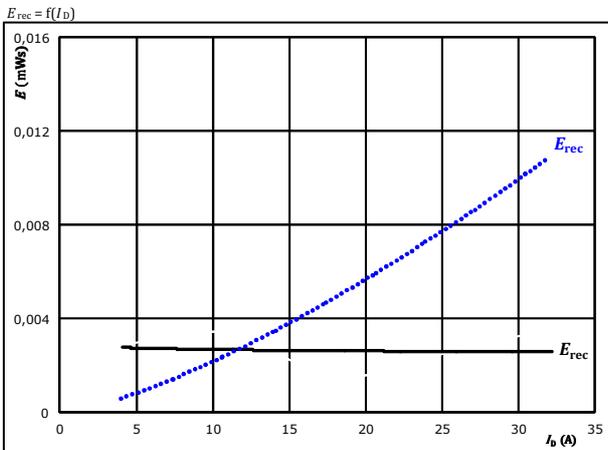
Typical switching energy losses as a function of gate resistor



With an inductive load at
 $V_{DS} = 400$ V
 $V_{GS} = 10$ V
 $I_D = 18$ A
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)

figure 3. FWD

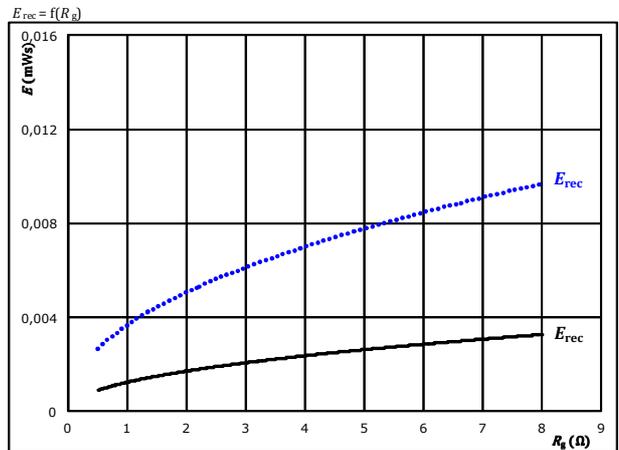
Typical reverse recovered energy loss as a function of drain current



With an inductive load at
 $V_{DS} = 400$ V
 $V_{GS} = 10$ V
 $R_{g\text{on}} = 2$ Ω
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)

figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor

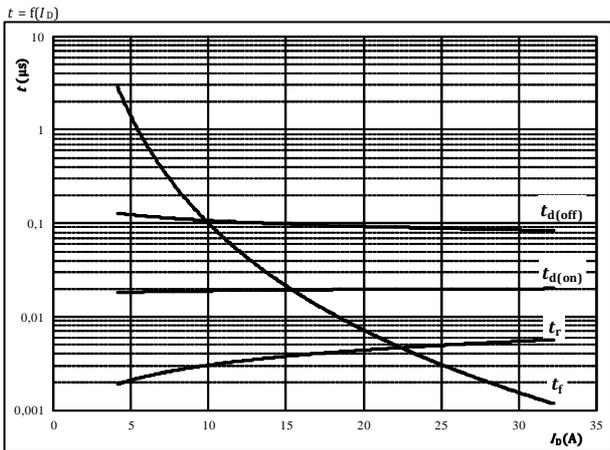


With an inductive load at
 $V_{DS} = 400$ V
 $V_{GS} = 10$ V
 $I_D = 18$ A
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)



PFC Switching Characteristics

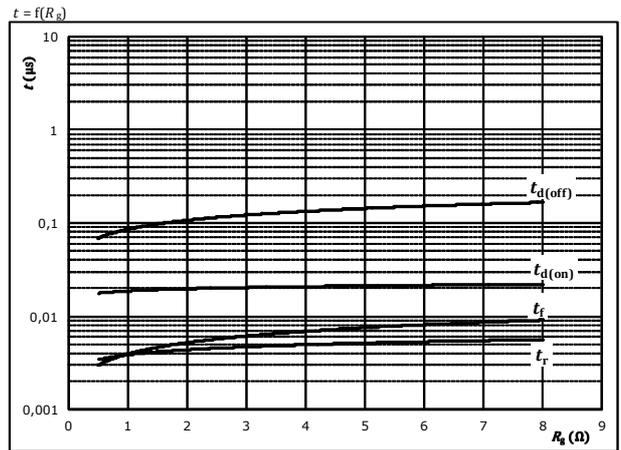
figure 5. MOSFET
Typical switching times as a function of drain current



With an inductive load at

- $T_j = 125 \text{ }^\circ\text{C}$
- $V_{DS} = 400 \text{ V}$
- $V_{GS} = 10 \text{ V}$
- $R_{g\text{on}} = 2 \text{ } \Omega$
- $R_{g\text{off}} = 2 \text{ } \Omega$

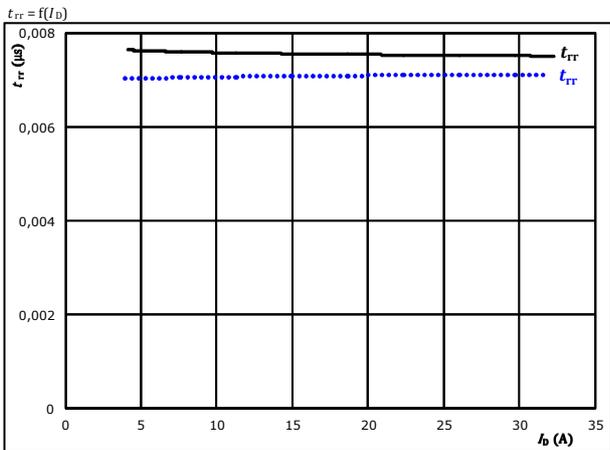
figure 6. MOSFET
Typical switching times as a function of gate resistor



With an inductive load at

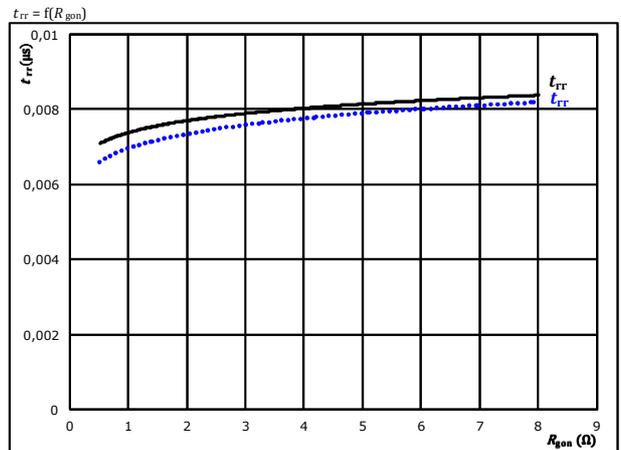
- $T_j = 125 \text{ }^\circ\text{C}$
- $V_{DS} = 400 \text{ V}$
- $V_{GS} = 10 \text{ V}$
- $I_D = 18 \text{ A}$

figure 7. FWD
Typical reverse recovery time as a function of drain current



- At $V_{DS} = 400 \text{ V}$
 $V_{GS} = 10 \text{ V}$
 $R_{g\text{on}} = 2 \text{ } \Omega$
- $T_j: 25 \text{ }^\circ\text{C}$ (dotted blue line)
 $125 \text{ }^\circ\text{C}$ (solid black line)

figure 8. FWD
Typical reverse recovery time as a function of MOSFET turn on gate resistor



- At $V_{DS} = 400 \text{ V}$
 $V_{GS} = 10 \text{ V}$
 $I_D = 18 \text{ A}$
- $T_j: 25 \text{ }^\circ\text{C}$ (dotted blue line)
 $125 \text{ }^\circ\text{C}$ (solid black line)

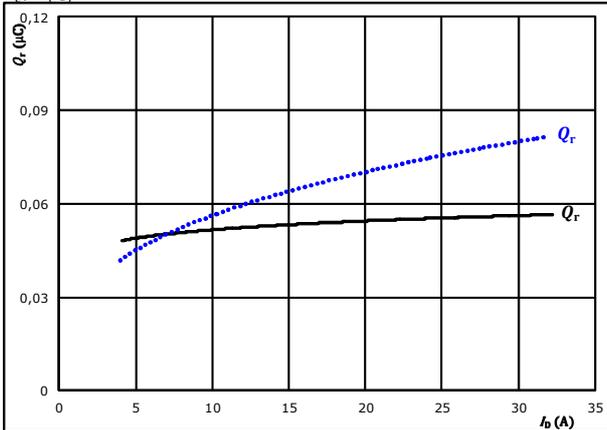


PFC Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of drain current

$Q_r = f(I_D)$

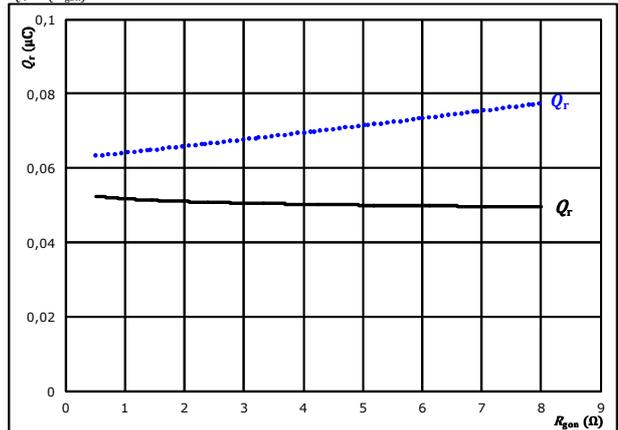


At $V_{DS} = 400$ V $T_j: 25$ °C
 $V_{GS} = 10$ V $T_j: 125$ °C ———
 $R_{ggn} = 2$ Ω

figure 10. FWD

Typical recovered charge as a function of MOSFET turn on gate resistor

$Q_r = f(R_{ggn})$

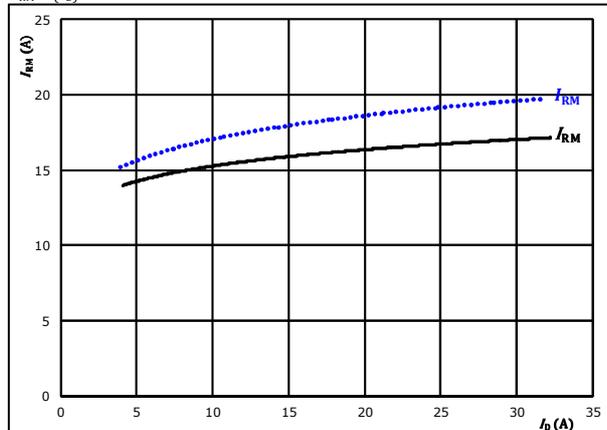


At $V_{DS} = 400$ V $T_j: 25$ °C
 $V_{GS} = 10$ V $T_j: 125$ °C ———
 $I_D = 18$ A

figure 11. FWD

Typical peak reverse recovery current as a function of drain current

$I_{RM} = f(I_D)$

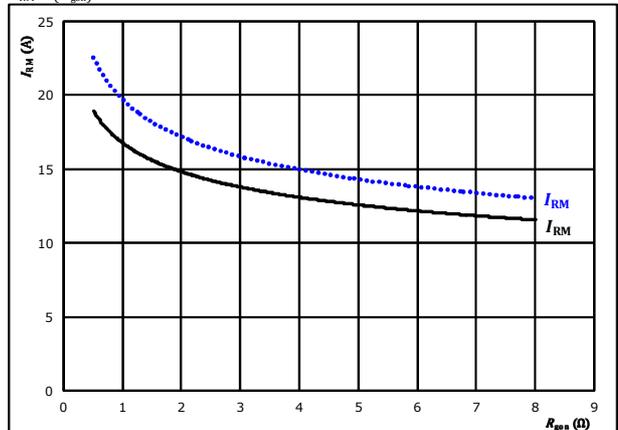


At $V_{DS} = 400$ V $T_j: 25$ °C
 $V_{GS} = 10$ V $T_j: 125$ °C ———
 $R_{ggn} = 2$ Ω

figure 12. FWD

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor

$I_{RM} = f(R_{ggn})$



At $V_{DS} = 400$ V $T_j: 25$ °C
 $V_{GS} = 10$ V $T_j: 125$ °C ———
 $I_D = 18$ A

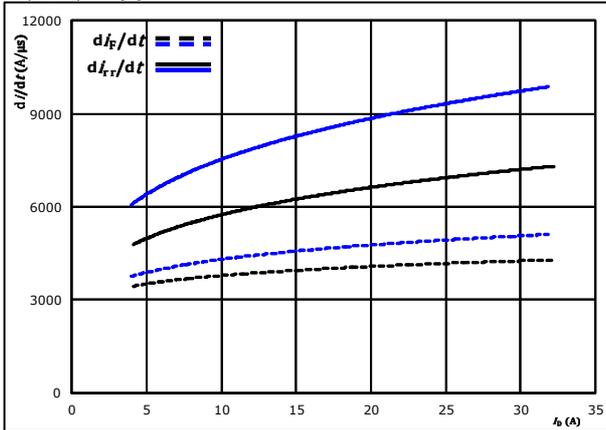


PFC Switching Characteristics

figure 13. FWD

Typical rate of fall of forward and reverse recovery current as a function of drain current

$$di_F/dt, di_{rr}/dt = f(I_D)$$

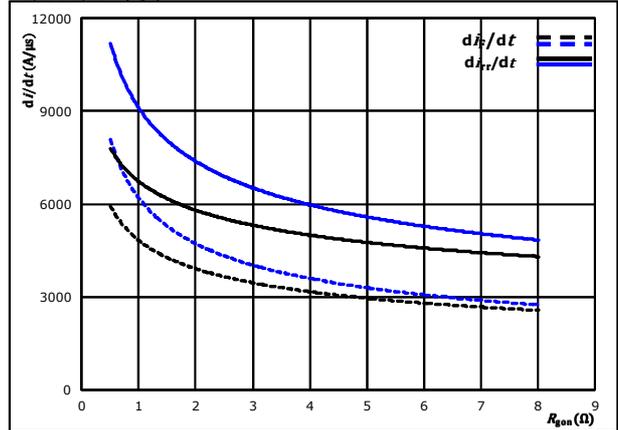


At $V_{DS} = 400$ V
 $V_{GS} = 10$ V
 $R_{gon} = 2$ Ω
 $T_j = 25$ °C
 $T_j = 125$ °C

figure 14. FWD

Typical rate of fall of forward and reverse recovery current as a function of MOSFET turn on gate resistor

$$di_F/dt, di_{rr}/dt = f(R_{gon})$$

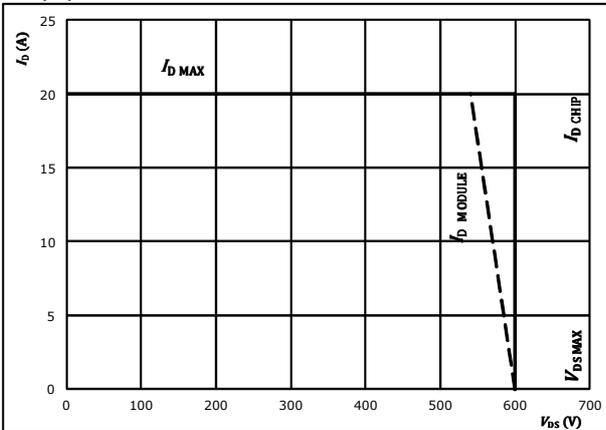


At $V_{DS} = 400$ V
 $V_{GS} = 10$ V
 $I_D = 18$ A
 $T_j = 25$ °C
 $T_j = 125$ °C

figure 15. MOSFET

Reverse bias safe operating area

$$I_D = f(V_{DS})$$



At $T_j = 150$ °C
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω



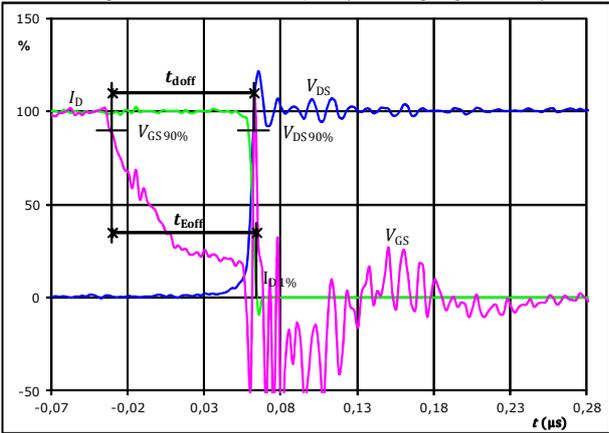
PFC Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	2 Ω
R_{goff}	=	2 Ω

figure 1. MOSFET

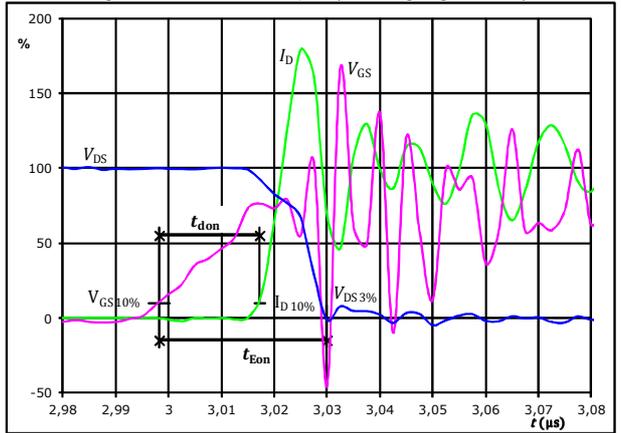
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for Eoff)



$V_{GS}(0\%) =$	0	V
$V_{GS}(100\%) =$	10	V
$V_{DS}(100\%) =$	400	V
$I_D(100\%) =$	18	A
$t_{doff} =$	0,092	μs
$t_{Eoff} =$	0,094	μs

figure 2. MOSFET

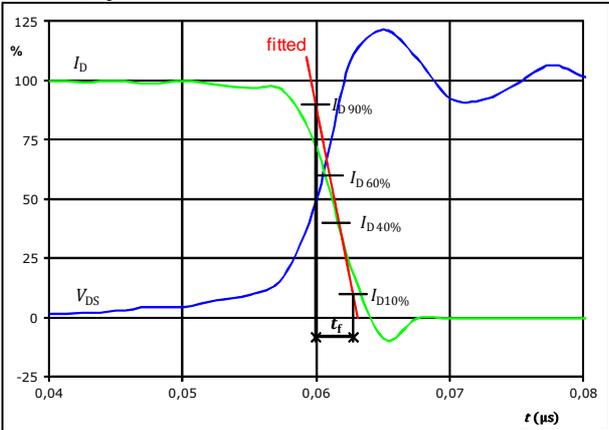
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for Eon)



$V_{GS}(0\%) =$	0	V
$V_{GS}(100\%) =$	10	V
$V_{DS}(100\%) =$	400	V
$I_D(100\%) =$	18	A
$t_{don} =$	0,019	μs
$t_{Eon} =$	0,032	μs

figure 3. MOSFET

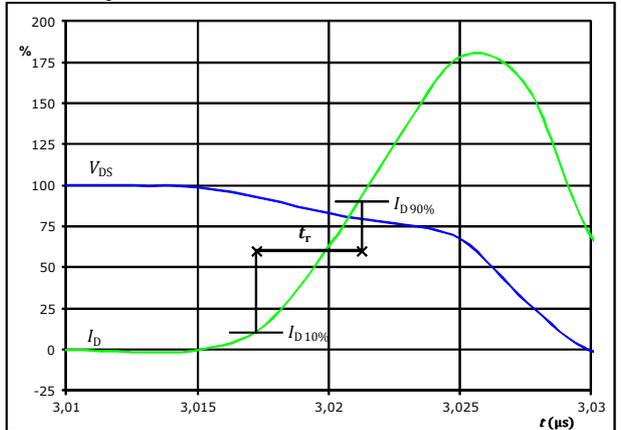
Turn-off Switching Waveforms & definition of t_f



$V_{DS}(100\%) =$	400	V
$I_D(100\%) =$	18	A
$t_f =$	0,004	μs

figure 4. MOSFET

Turn-on Switching Waveforms & definition of t_r



$V_{DS}(100\%) =$	400	V
$I_D(100\%) =$	18	A
$t_r =$	0,004	μs

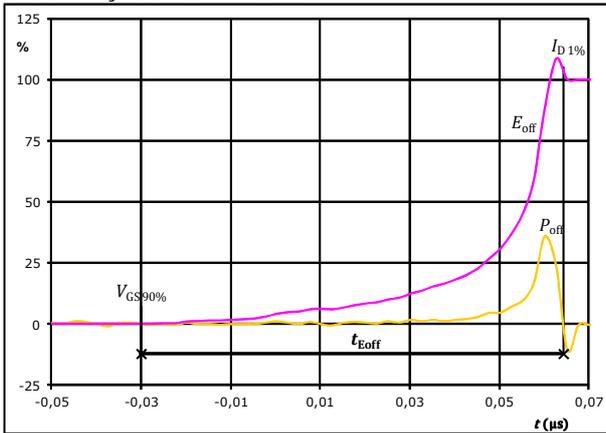


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PFC Switching Definitions

figure 5. MOSFET

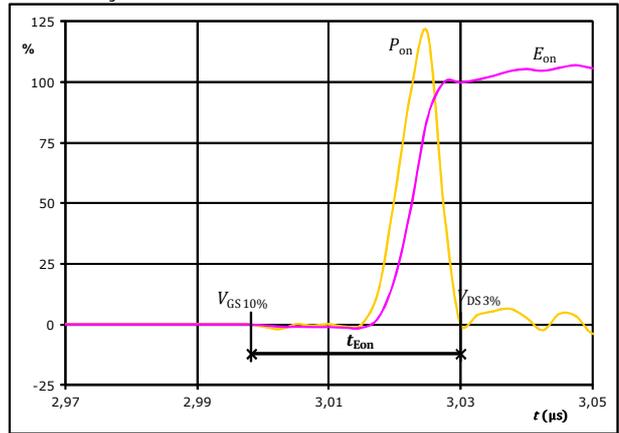
Turn-off Switching Waveforms & definition of t_{Eoff}



$P_{off}(100\%) = 7,21$ kW
 $E_{off}(100\%) = 0,02$ mJ
 $t_{Eoff} = 0,09$ μs

figure 6. MOSFET

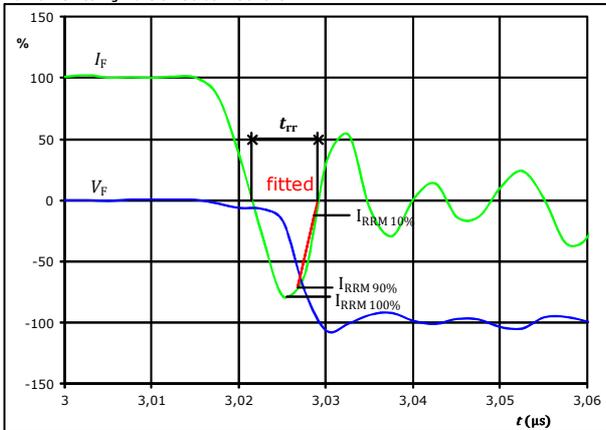
Turn-on Switching Waveforms & definition of t_{Eon}



$P_{on}(100\%) = 7,21$ kW
 $E_{on}(100\%) = 0,06$ mJ
 $t_{Eon} = 0,03$ μs

figure 7. FWD

Turn-off Switching Waveforms & definition of t_{tr}

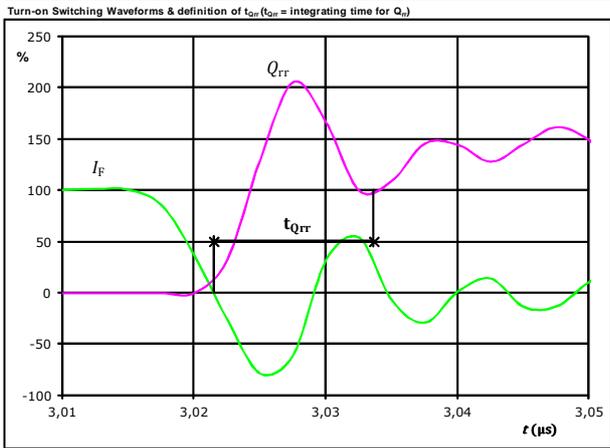


$V_F(100\%) = 400$ V
 $I_F(100\%) = 18$ A
 $I_{RRM}(100\%) = -16$ A
 $t_{tr} = 0,007$ μs



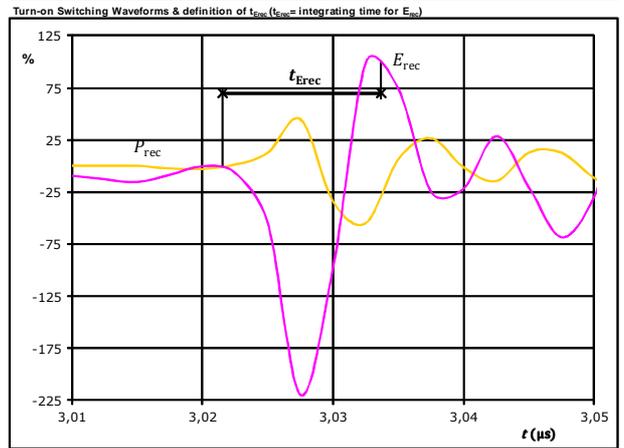
PFC Switching Definitions

figure 8. FWD



I_F (100%) =	18	A
Q_{rr} (100%) =	0,05	μ C
t_{Qrr} =	0,01	μ s

figure 9. FWD



P_{rec} (100%) =	7,21	kW
E_{rec} (100%) =	0,002	mJ
t_{Erec} =	0,01	μ s



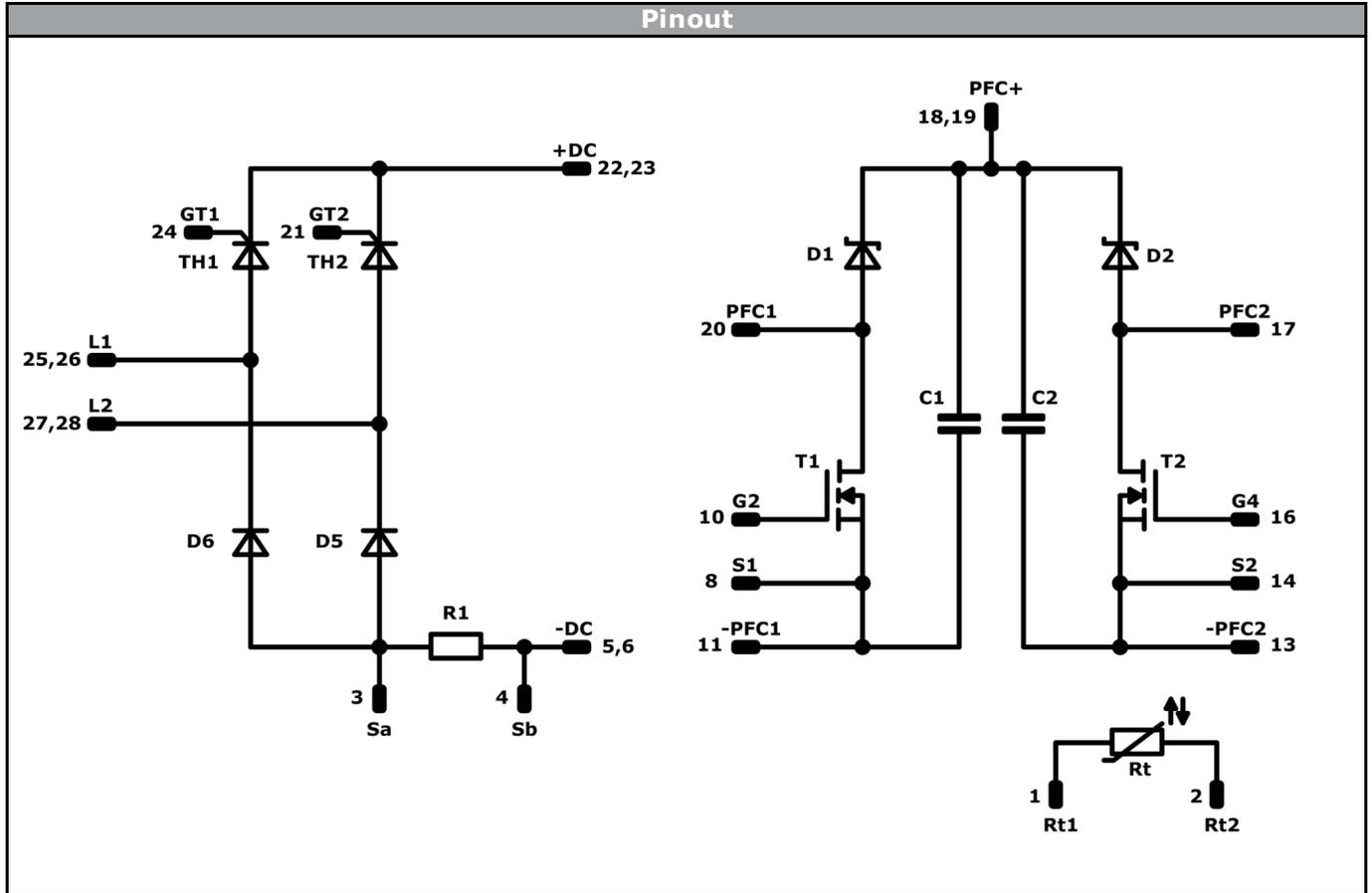
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Ordering Code & Marking							
Version			Ordering Code				
without thermal paste with Solder pins 17mm housing			10-F0062TA099FS-P980D59				
NN-NNNNNNNNNNNNNN TTTTIVV WWYY UL Vinco LLLLL SSSS		Text	Name	Date code	UL & Vinco	Lot	Serial
			NN-NNNNNNNNNNNNNN-TTTTIVV WWYY UL Vinco LLLLL SSSS	WWYY UL Vinco LLLLL SSSS	UL Vinco LLLLL SSSS	LLLLL SSSS	SSSS WWYY
		Datamatrix	Type&Ver	Lot number	Serial	Date code	
			TTTTTIVV	LLLLL	SSSS	WWYY	

Pin table [mm]				Outline	
Pin	X	Y	Function		
1	33,5	0	Rt1		
2	33,5	2,8	Rt2		
3	29,5	2,8	Sa		
4	29,5	0	Sb		
5	26,7	0	-DC		
6	23,9	0	-DC		
7	21,05	0	N.C.		
8	14,85	0	S1		
9	not assembled				
10	12,05	0	G2		
11	9,5	12,05	-PFC1		
12	8,2	0	N.C.		
13	6,7	12,05	-PFC2		
14	3,9	0	S2		
15	not assembled				
16	1,1	0	G4		
17	0	22,7	PFC2		
18	7,1	22,7	PFC+		
19	7,1	20,2	PFC+		
20	14,2	22,7	PFC1		
21	20,7	22,7	GT2		
22	23,5	22,7	+DC		
23	26	22,7	+DC		
24	28,8	22,7	GT1		
25	33,5	18,55	L1		
26	33,5	16,05	L1		
27	33,5	8,7	L2		
28	31	8,7	L2		



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Identification					
ID	Component	Voltage	Current	Function	Comment
T1, T2	MOSFET	600V	99mΩ	PFC Switch	
D1, D2	FWD	600V	10A	PFC Diode	
D5, D6	Rectifier	1600V	50A	Rectifier Diode	
TH1, TH2	Thyristor	1200V	26A	Rectifier Thyristor	
R1	Resistor			PFC Shunt	
C1, C2	Capacitor	500V		PFC Capacitance	
Rt	NTC			Thermistor	



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Packaging instruction					
Standard packaging quantity (SPQ)	135	>SPQ	Standard	<SPQ	Sample

Handling instruction	
Handling instructions for <i>flow</i> 0 packages see vincotech.com website.	

General datasheet	
General datasheet for <i>flow</i> 0 packages see vincotech.com website.	

Document No.:	Date:	Modification:	Pages
10-F0062TA099FS-P980D59-D2-14	08 Feb. 2016	Features correction	1

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.